

INTERNATIONAL STANDARD

NORME INTERNATIONALE

**Field Device Integration (FDI) –
Part 3: FDI Server**

**Intégration des appareils de terrain (FDI) –
Partie 3: Serveur FDI**

Withdrawing



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FIELD DEVICE INTEGRATION (FDI) –

Part 3: FDI Server

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The text of this standard is based on the following documents:

CDV	Report on voting
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Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

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